

N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$V_{DS}(V)$ $R_{DS(on)}(\Omega)$		Q _g (Typ.)			
60	0.075 at V _{GS} = 10 V	4.0	2.1 nC			
	0.086 at V _{GS} = 4.5 V	3.8	2.1110			

FEATURES

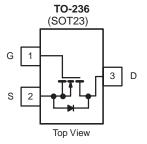
- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- 100 % UIS Tested

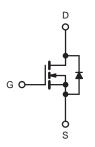
RoHS COMPLIANT HALOGEN

FREE

APPLICATIONS

- Battery Switch
- DC/DC Converter





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS TA	$_{\Lambda}$ = 25 °C, unless other	erwise noted		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	60	V	
Gate-Source Voltage	V _{GS}	± 20		
	T _C = 25 °C		4.0	
Continuous Drain Current (T _{.1} = 150 °C)	$T_C = 70 ^{\circ}C$	I_	3.4	
Continuous Diam Current (1) = 130 °C)	T _A = 25 °C	ID	3.1 ^{b, c}	
	T _A = 70 °C		2.5 ^{b, c}	
Pulsed Drain Current	I _{DM}	12	A	
Continuous Source-Drain Diode Current	T _C = 25 °C	I.	1.39	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	0.91 ^{b, c}	
Avalanche Current		I _{AS}	6	
Single-Pulse Avalanche Energy L = 0.1 mH		E _{AS}	1.8	mJ
	T _C = 25 °C		1.66	
Maximum Dawar Dissination	T _C = 70 °C	В	1.06	w
Maximum Power Dissipation	T _A = 25 °C	P _D	1.09 ^{b, c}	VV
	T _A = 70 °C		0.7 ^{b, c}	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	≤ 5 s	R _{thJA}	90	115	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	60	75	C/VV	

Notes

- a. Based on $T_C = 25$ °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s
- d. Maximum under Steady State conditions is 120 °C/W.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static				1	•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 \text{ V, } I_{D} = 250 \mu\text{A}$	60			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 vA		55		mV/°
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_{J}$	I _D = 250 μA		- 5		
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1		3	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zara Cata Valtaga Drain Current	1 .	V _{DS} = 60 V, V _{GS} = 0 V			1	μA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V, T _J = 55 °C			10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	8			Α
	В	V _{GS} = 10 V, I _D = 1.9 A		0.075		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 1.7 \text{ A}$		0.086		Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15V, I _D = 1.9 A		5		S
Dynamic ^b				1		
Input Capacitance	C _{iss}			180		
Output Capacitance	C _{oss}			22		pF
Reverse Transfer Capacitance	C _{rss}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		13		
T. 10 . 0	otal Gate Charge $Q_g = V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 1.9 \text{ A}$	V _{DS} = 30 V, V _{GS} = 10 V, I _D = 1.9 A		4.2	6.1	
Total Gate Charge				2.1	3.2	nC
Gate-Source Charge	Q_{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 1.9 \text{ A}$		0.7		
Gate-Drain Charge	Q_{gd}			1		
Gate Resistance	R _g	f = 1 MHz	0.6	2.2	5.1	Ω
Turn-On Delay Time	t _{d(on)}			4	6	ns
Rise Time	t _r	V_{DD} = 30 V, R_L = 20 Ω		10	15	
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ 1.5 A, V_{GEN} = 10 V, R_G = 1 Ω		10	15	
Fall Time	t _f			7	10.5	
Turn-On Delay Time	t _{d(on)}			15	23	
Rise Time	t _r	V_{DD} = 30 V, R_L = 20 Ω		16	24	ns
Turn-Off Delay Time	t _{d(off)}	$I_D = 1.5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_G = 1 \Omega$		11	17	
Fall Time	t _f			11	17	
Drain-Source Body Diode Characteristi	cs			1		
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			2.19	_
Pulse Diode Forward Current ^a	I _{SM}				7	_ A
Body Diode Voltage	V _{SD}	I _S = 1.5 A		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			15	23	ns
Body Diode Reverse Recovery Charge	Q _{rr}			10	15	nC
Reverse Recovery Fall Time	t _a	$I_F = 1.5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		12		
Reverse Recovery Rise Time	t _b			3		ns

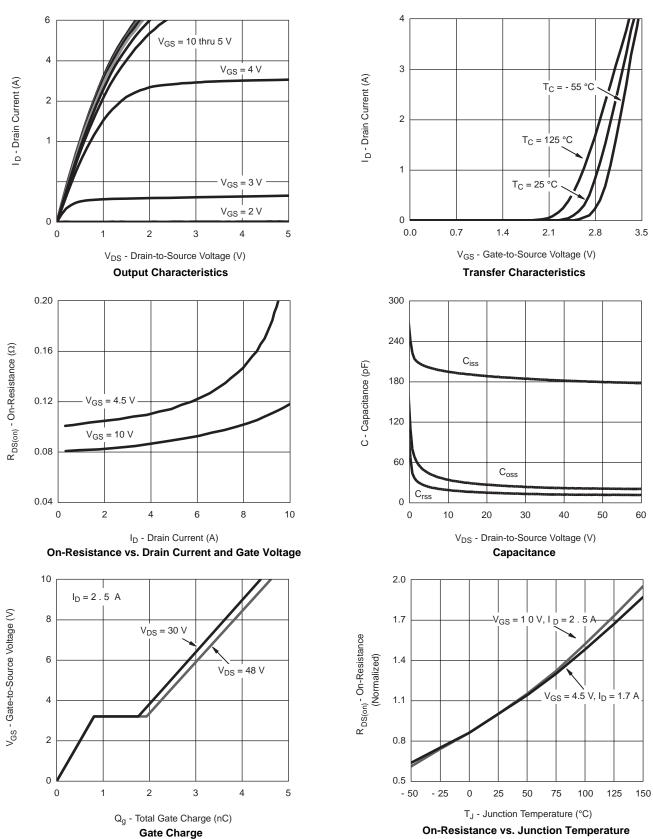
Notes:

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

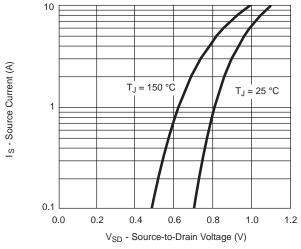


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

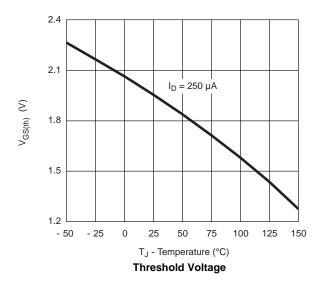


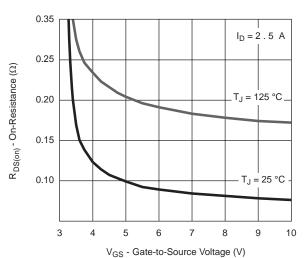


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

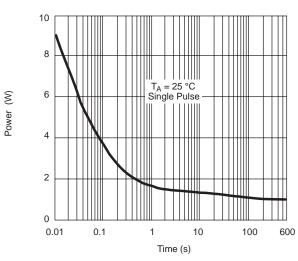


Source-Drain Diode Forward Voltage

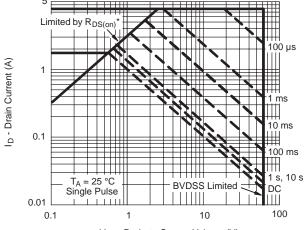




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power



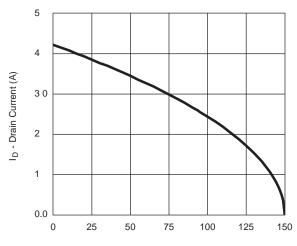
V_{DS} - Drain-to-Source Voltage (V)

Safe Operating Area

^{*} V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

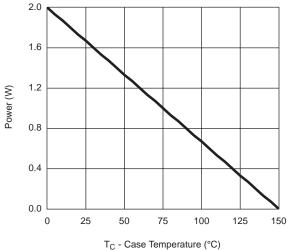


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

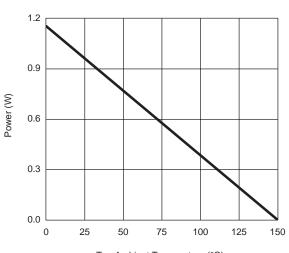


T_C - Case Temperature (°C)

Current Derating*







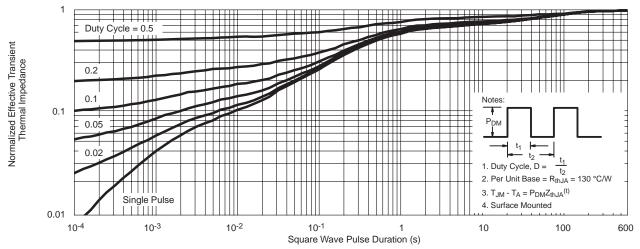
T_A - Ambient Temperature (°C) **Power Derating, Junction-to-Ambient**

Power Derating, Junction-to-Case

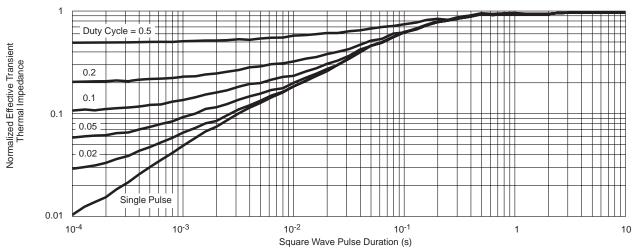
^{*} The power dissipation P_D is based on $T_{J(max.)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



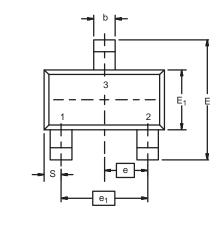
Normalized Thermal Transient Impedance, Junction-to-Ambient

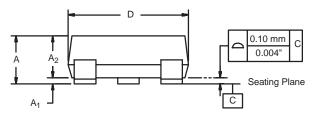


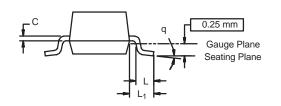
Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-23 (TO-236): 3-LEAD





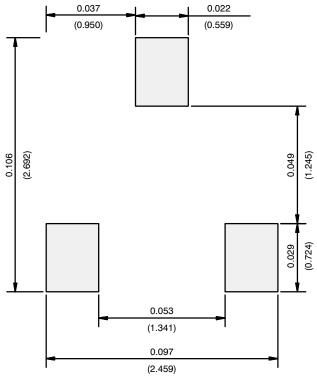


Dim	MILLIN	IETERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
ECN: S-03946-Rev. K. 09-	Jul-01				

DWG: 5479



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)



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IRS2092STRPBF-EL IPS70R2K0CEAKMA1 TK31J60W5,S1VQ(O TK31J60W,S1VQ(O TK16J60W,S1VQ(O 2SK2614(TE16L1,Q)
DMN1017UCP3-7 EFC2J004NUZTDG P85W28HP2F-7071 DMN1053UCP4-7 NTE2384 DMC2700UDMQ-7 DMN2080UCB4-7
DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B IPS60R3K4CEAKMA1 DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 IPS60R360PFD7SAKMA1
DMN2990UFB-7B SSM3K35CT,L3F IPLK60R1K0PFD7ATMA1 2N7002W-G MCAC30N06Y-TP IPWS65R035CFD7AXKSA1
MCQ7328-TP SSM3J143TU,LXHF DMN12M3UCA6-7 PJMF280N65E1_T0_00201 PJMF380N65E1_T0_00201
PJMF280N60E1_T0_00201 PJMF600N65E1_T0_00201 PJMF900N65E1_T0_00201